

Form PTO-1449	Patent Number (Optional)	Assignment Number
INFORMATION DISCLOSURE CITATION IN AN APPLICATION		
OCT 22 2003 USPTO severals shows it not necessary	TSMC-02-360	10/618,536
	Applicant Jean-Chen Lin et al.	
Filing Date	Drawn At This 07/11/03	

~~U.S.~~ PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

OTHER DOCUMENTS (including Author, Title, Date, Portion of Page, Etc.)

TT -	TSMC-01-1676, Serial No. 10/361,732, filed on 02/10/03, assigned to common assignee, "Barrier Free Copper Interconnect by Multi-Layer Copper Seed".
TT -	TSMC-02-338, Serial No. 10/350,837, filed on 01/24/03, assigned to common assignee, "Improved Method of Barrier-less Integration with Copper Alloy".

EXAMINER: Initial if citation considered; whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.